Keywords:

Article number: ICK S R 32,5X

Search for products

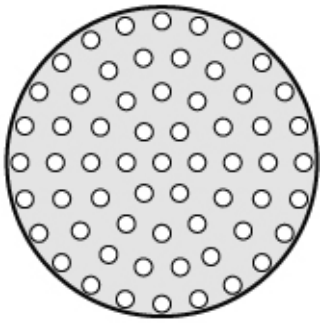
Product groups:

- Profile heatsinks and fluid coolers
- Heatsinks and active heatsinks for processors
- Finger-shaped heatsinks
- Cooling aggregates
- Accessories for electronic components

Back to list of products

Product group:
Heatsinks and active heatsinks for processors > Pin heatsinks

Pin heatsinks / **ICK S R 32,5 x 20**



Ø 32,5 x 20 mm, pin heatsinks round

Parameters of article ICK S R 32,5 x 20

Bauform	Rund
R_{th} [K/W]	5.6
dissipation loss [W]	8.9
mounting method	therm. conductive foil / therm. cond. adhesive
socket	universal
suitable for processor type	universal
Ø [mm]	32.5
heigth [mm]	20
plate thickness [mm]	3
weight [g]	13.8

Technical
Drawing

Accessories/ related articles

Thermally conductive foil both sides adhesive / **WLFT 404 D 32**

Thermally conductive foil both sides adhesive / **WLFT 405 D 32**

Download CAD Drawing

PDF

DXF

IGS

Unikeyic Electronics

Global Electronic Components Distributor

Click to view pricing, inventory, delivery, and lifecycle information:

Fischer Elektronik:

FK 224 SA P SIP P SIP FK 244 13 D2 PAK TO-263 (D2PAK) KL35050 SK 85 50 SA FK 245 MI 247 H LA ICK 17 X17 W 12V MS 53 3 WLK 5 SK 104 38,1 STS SK 58 50 SA FK 247 220 MI TO 220 LA 17/200 24V LA 7/150 24V SK0937,5TO220 SK68-37,5-SA BLY 1 50 Z FK 232 220 SA SK68-50SA WKT 300 SK 04 100 SA FK 240 SA 220 V SK 198 1000 AL SK 85 100 SA SL 11 190 36 G SL 22 112 72 G SL22 124-16G CC 35 67 100 ME SK 88 50 SA THFK247 TUF 80 42 100 SA